

Description

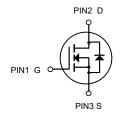
The 18N50F can be used in various power swithching circuit for system miniaturization and higher efficiency. The package form is TO-220/TO-220F, which accords with the RoHS standard.

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TO-220F

General Features

 $V_{DS} = 500V, I_{D} = 18A$ $R_{DS(ON)} < 0.38 \Omega@ V_{GS} = 10V$



N-Channel MOSFET

Application

• Power switch circuit of adaptor and charger.

Package Marking and Ordering Information

Product ID	Pack	Marking	Units Tube
18N50F	TO-220F	18N50 XXX YYYY	50

Absolute Maximum Ratings@T=25°C(unless otherwise specified)

Symbol	Parameter	L mit	Unit	
V _{DSS}	Drain-to-Source Voltage ^[1]	500	V	
V _{GSS}	Gate-to-Source Voltage	±30		
I _{D @ Tc =100} ℃	Continuous Drain Current @ Tc=100℃	18	Α	
I _{DM}	Pulsed Drain Current at V _{GS} =10V ^[2]	72		
E _{AS}	Single Pulse Avalanche Energy	710	mJ	
P _D	Power Dissipation	65	W	
T _L T _{PAK}	Maximum Temperature for Soldering Leads at 0.063in (1.6mm) from Case for 10 seconds, Package Body for 10 seconds	300 260	$^{\circ}$	
T _J & T _{STG}	Operating and Storage Temperature Range	-55 to 150		
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case	1.92	°C 141	
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient	62.5	°CM	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.



Electrical Characteristics T_J = 25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	500			V	V _{GS} =0V, I _D =250uA
I _{DSS}	Drain-to-Source Leakage Current			1	uA	V _{DS} =500V, V _{GS} =0V
				100		V_{DS} =400V, V_{GS} =0V, T_J =125°C
I _{GSS} G	Gate-to-Source Leakage Current			+100	nA	V _{GS} ==30V, V _{DS} =0V
				-100		V _{GS} =-30V, V _{DS} =0V
R _{DS(ON)}	Static Drain-to-Source On-Resistance		0.30	0.38	Ω	V _{GS} =10V, I _D =6.5A
$V_{GS(TH)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS}=V_{GS}$, $I_{D}=250uA$
gfs	Forward Transconductance		11		S	VDS=30V,ID=13A
C _{iss}	Input Capacitance		2100			\/ -0\/
C _{rss}	Reverse Transfer Capacitance		190		pF	V_{GS} =0V, V_{DS} =25V, f =1.0MH $_{Z}$
C _{oss}	Output Capacitance		100			
Qg	Total Gate Charge		48			V _{DD} =400V, I _D =18A, V _{GS} =10V
Q _{gs}	Gate-to-Source Charge		11		nC	
Q _{gd}	Gate-to-Drain (Miller) Charge		3.1			
td(ON)	Turn-on Delay Time		110			V_{DD} =300V, I_{D} =18A, V_{GS} =10V Rg =25 Ω
trise	Rise Time		70			
td(OFF)	Turn-Off Delay Time		190		ns	
tfall	Fall Time		100			
I _{SD}	Continuous Source Current ^[2]			13	A	Integral pn-diode in MOSFET
I _{SM}	Pulsed Source Current ^[2]			52	A	
V _{SD}	Diode Forward Voltage			1.5	V	I _S =18A, V _{GS} =0V
trr	Reverse Recovery Time		550		ns	Vgs=0V
Qrr	Reverse Recovery Charge		5.5		uC	I _F =18A, di/dt=100A/μs

Note:

[1] T_J =+25°C to +150°C [2] Pulse width≤380 μ s; duty cycle≤2%.

Typical Characteristics

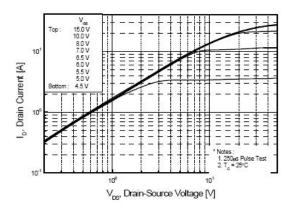


Fig1 Typical Output Characteristics, Tc=25 °C

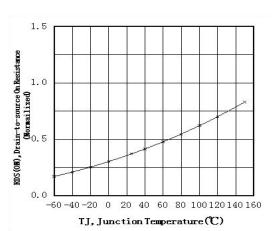


Fig2 On-Resistance Vs.Drain Current and Gate Voltage

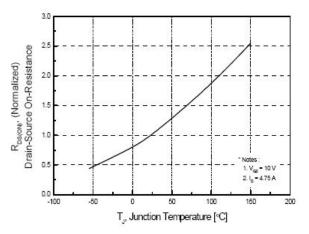


Fig3 Normalized On-Resistance Vs. Temperature

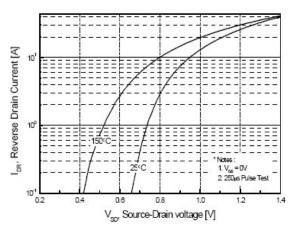


Fig4 Typical Source-Drain Diode Forward Voltage

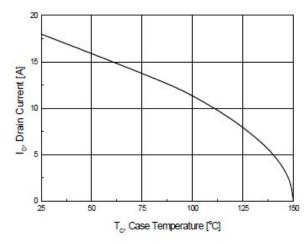


Fig5 Maximum Drain Current Vs.Case Temperature

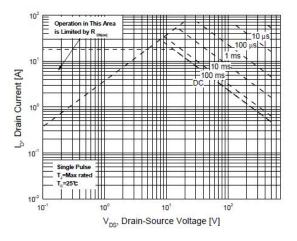
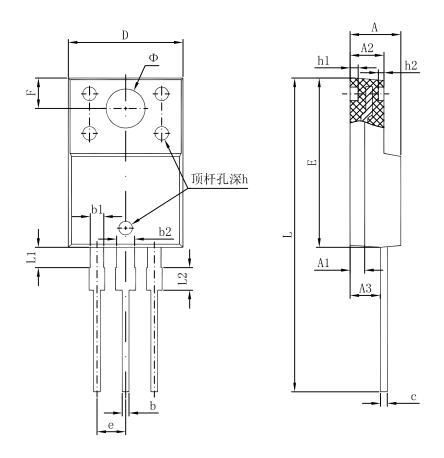


Fig6 Maximum Safe Operating Area

Package Dimension TO-220F



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	4.300	4.700	0.169	0.185	
A1	1.300 REF.		0.051 REF.		
A2	2.800	3.200	0.110	0.126	
A3	2.500	2.900	0.098	0.114	
b	0.500	0.750	0.020	0.030	
b1	1.100	1.350	0.043	0.053	
b2	1.500	1.750	0.059	0.069	
С	0.500	0.750	0.020	0.030	
D	9.960	10.360	0.392	0.408	
E	14.800	15.200	0.583	0.598	
е	2.540 TYP.		0.100 TYP.		
F	2.700 REF.		0.106 REF.		
Φ	3.500 REF.		0.138 REF.		
h	0.000	0.300	0.000	0.012	
h1	0.800 REF.		0.031 REF.		
h2	0.500 REF.		0.020 REF.		
L	28.000	28.400	1.102	1.118	
L1	1.700	1.900	0.067	0.075	
L2	1.900	2.100	0.075	0.083	



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